

NCR-N°:	0016	Revision
Related inter	rnal NCR-No	D.:
Critical Item:	Yes X	No 🗖
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NCR Title SO-EPD-KIE-NC-0016 post Vib FT anomalies				
NC Item <u>Identification</u> EPT-HET Name: Sr-N: CI-No.:		Drawing No.		
Next higher Assembly EPD		Procedure No.		
Subsystem Model . PC	QM .	Supplier: CAU Kiel		
NC <u>Observation</u> Date: 2015-05-20 Location: Portsmo	uth ADS Facilities	NC detected during: Test, after Z-a	xis qual random	
After an apparently nominal start to datvibration test, the input current was obsiminates this current gradually reduced were excessively noisy. Data acquisitio was stopped almost immediately when showed a short dropout of Vbias, and a nominal impedance check had been car	served to change to 2: to 190mA, but it was t n was stopped and th current fluctuations (later gradual decreas	40mA from the nominal 180mA. Du found that all eight EPT channels a e instrument powered off at 11:48. 160-210mA) were observed. Post t	ring the following 20 and both HET channels A subsequent power on est quick analysis of HK	
Requirements violated:		Initiator: Date, Name and Signature 2015-05-20, S.Kulrarni		
Internal NRB Dispositions:	Ref. to MoMs attache Review Board, 29 Ma	d, PQM EPT-HET Non Conformance ay and 01 June.	Classification: Minor Major X	
Fault analysis was carried out as summaris Hardware was inspected at CAU Kiel. Dam attachment. Telecom with OHB confirmed parts and glu	nage to LVPS, Digital ar	nd Analog boards is itemised in	Customer Notification per email	
Cause of NC: Excessive bending under vib cause of strength of resonance to be investigated Ref to Failure Report	PQM EPT-HET further qualification PQM STEP – I	ventive Actions: F – rework for thermal test, but no ation RFD (tbd) for notching resonance and myloration levels	Verification: Test	
PA	Engineering			
Date: Name: Signature:	Skulkar <u>u i</u>			
<u>Customer NRB</u> Dispositions (Class major, only) Ref. to MoMs Verification				
Finally determined Cause of NC Ref to Failure Report	Corrective/Pre	ventive Actions		
Request for Waiver No Yes Reference:	Alert No Yes	Other related	Documents	
NRB Approval Chairman	1.0.0.0.00		NCR Close out	
Organization/Na me			Date, Signature, Stamp	

Nonconformance Report Solar Orbiter Energetic Particles Detector (EPD) EPT-HET X STEP : NCR-N°: ___0016___ Revision ____ Related internal NCR-No.: ____ Critical Item: Yes X No Page 2 of _11 Attachments:

Date, Signature			

Nonconformance Report

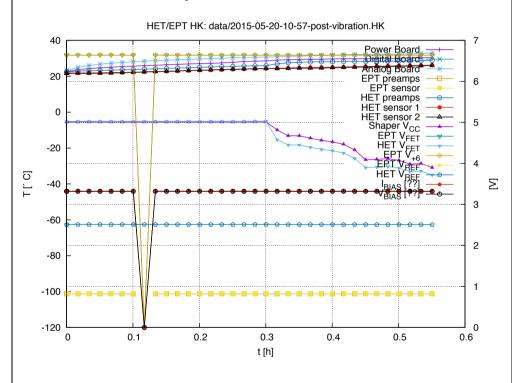
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- Continuation Sheet -

NCR Treatment Sequence / Findings / Statements / Actions

Verification

The first analysis of housekeeping was made at ADS Portsmouth environmental test facility immediately after the failure was observed. The following graphic shows a dropout in temperature sensors at HET Sensors 1 & 2, as well as bias voltage and current.



Summary of EPT-HET PQM fault analysis

(1) Email Bjoern Schuster

short summery from my side of the todays "autopsy".

The LVPS had sporadic errors in output voltages when pressing on PCB or by twisting the board, which let me believe to a broken solder connection. The behavior of the output voltages points to an error in the signal path on the primary side. And that is it, where the error was found.



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The LVPS has multiple cracks in pins of different parts. Two cracked pins of the PWM generator seems the be the reasons for the falling analog voltage during vibration.

One of the two cracked pins is the feedback input for PWM generator.

There are some more cracks I have found and I believe that there will be some more.

The cracks at PWM generator I have found because I had the strong suspicion that there is the source of error, so I have inspected this part very detailed.

I will fix this error tomorrow. But the parts on board are very stressed now and won't survive a second vibration test.

I don't believe that the LVPS is the reason for failure in the FPGA IO bank. We will see on tomorrow.

The attachment had six photos and assembly diagrams for location:

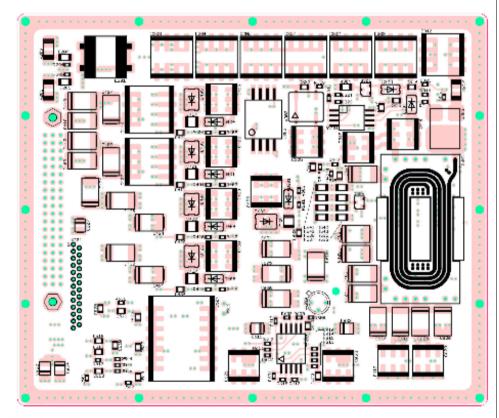
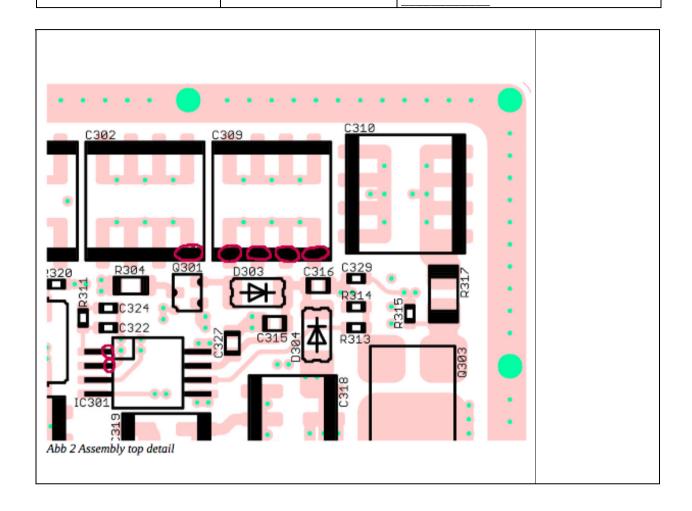


Abb 1 Assembly top

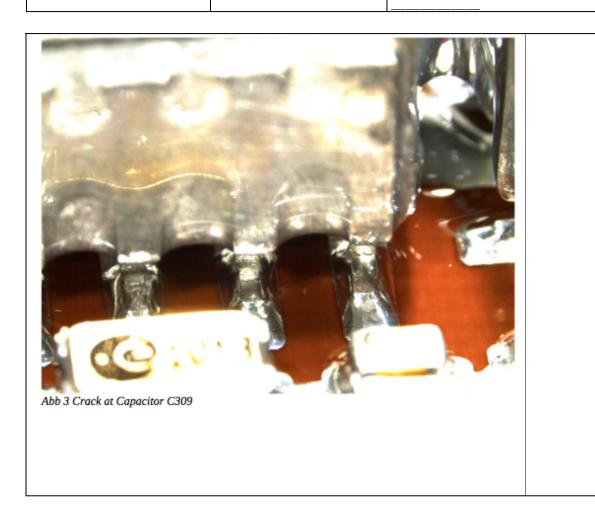


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Nonconformance Repor



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Abb 4 Crack at Capacitor C309 detail

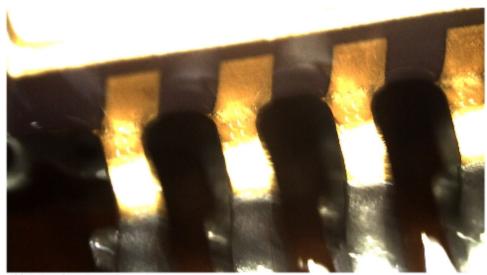


Abb 5 Crack on Pin 1 & at IC301



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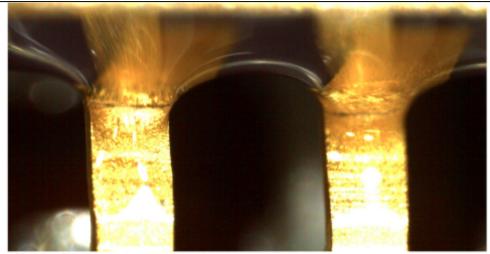


Abb 6 Crack on Pin 1 &2 at IC301 detail 01

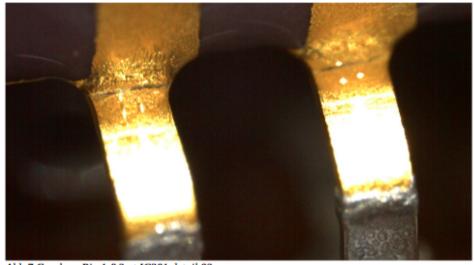


Abb 7 Crack on Pin 1 &2 at IC301 detail 02



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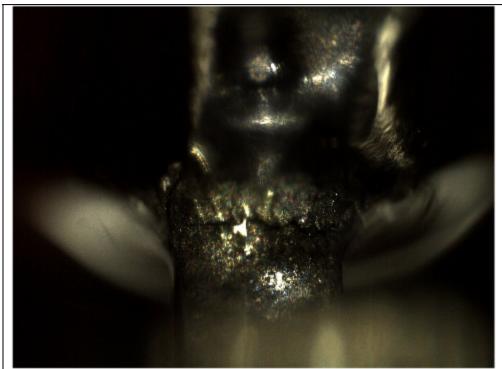
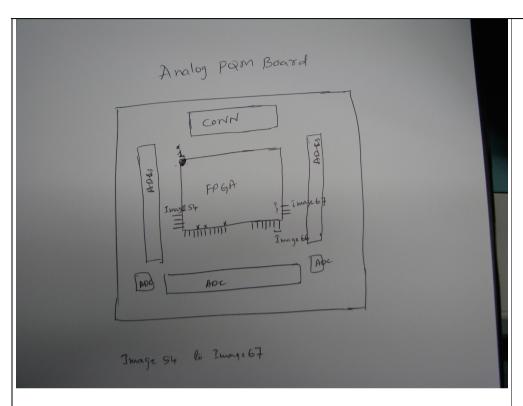


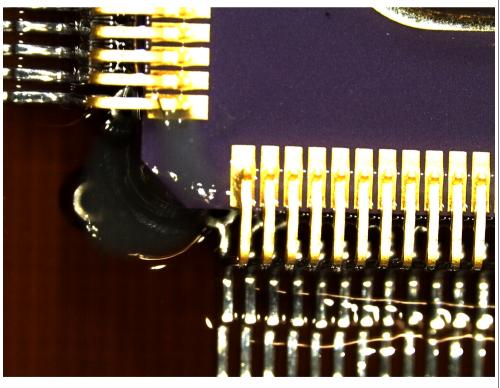
Abb 8 Crack at Capacitor C302

(2) On 2015-05-28 Shri Kulkarni posted his investigation of the Analog board. Cracks were observed in FPGA legs, as indicated in the sketched assembly diagram, and documented by photos.



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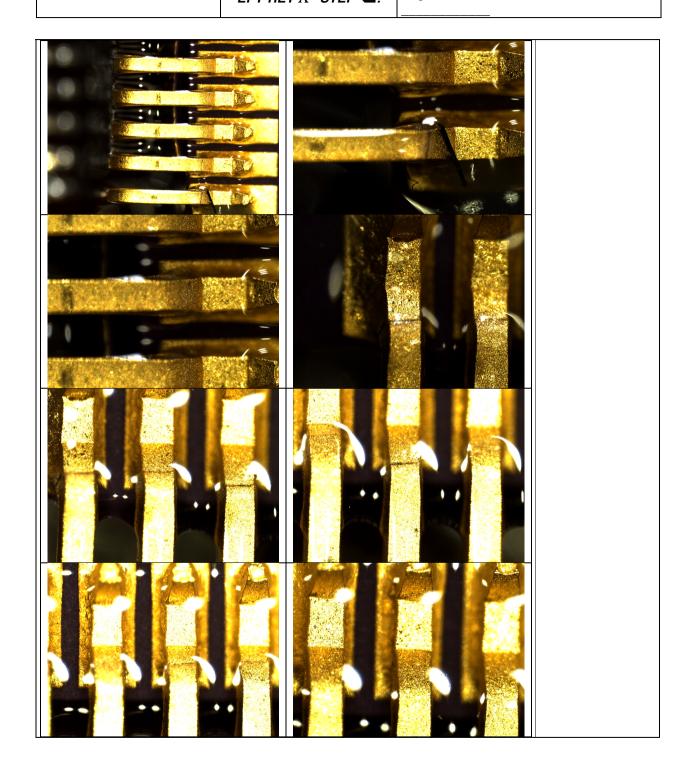




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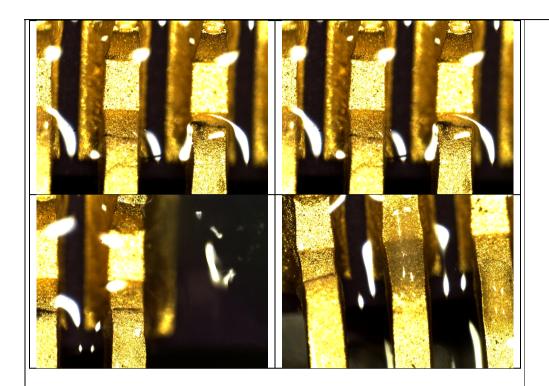




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(3) Successful test of EPT sensor head, email S. Kulkarni, 2015-05-29

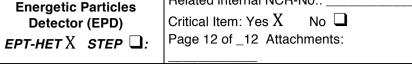
Test setup:

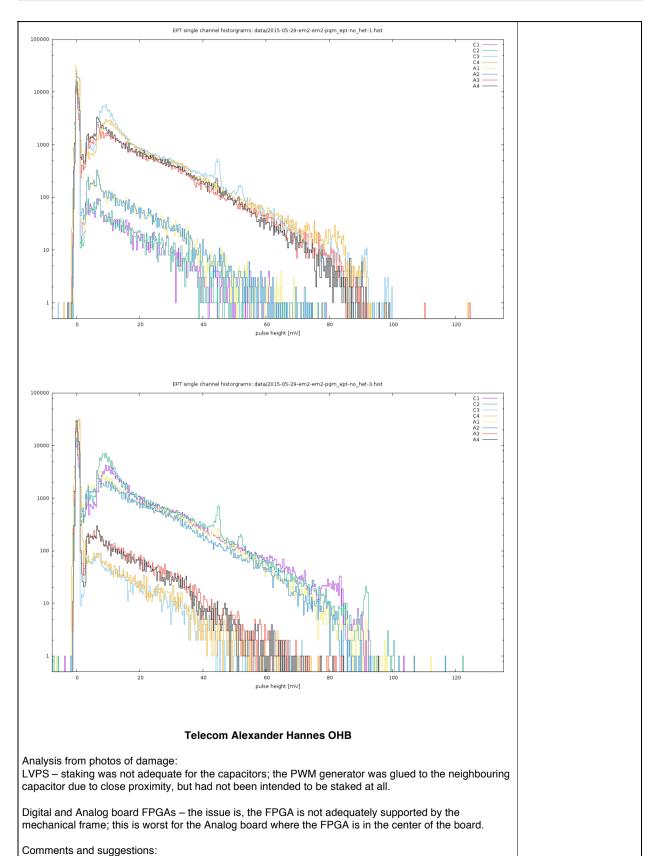
PQM EPT sensor head EM2 Analog board EM2 Digital board LDO Power board Bi207 source



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The staking is better on the PQM STEI Bending of the boards under vibration using thicker pcb would help, and impr For testing STEP, notching during vibration	is the cause of the FPGA broken legs roving the fixation of the boards to the	frame would help.	
Notes by M.L.Richards, 2015-06-03			